05-22-2002 FORM PTO-1595 (Modified) U.S. DEPARTMENT OF COMMERCE (Rev. 03-01) Patent and Trademark Office OMB No. 0651-0027 (exp.5/31/2002) P08/REV03 102099237 Tab settings 🔷 🔷 To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 1. Name of conveying party(ies): Name and address of receiving party(ies): Rajiv M. Ranade G. S. Mathad Name: Infineon Technologies North America Corp. 5-13-02 Internal Address: 3. Nature of conveyance: Street Address: 1730 North First Street ■ Assignment Merger Security Agreement Change of Name State: CA ZIP: 95112 City: San Jose Other Execution Date: 5/10/02, 5/10/02 Additional name(s) & address(es) attached? 

Yes 
No Application number(s) or patent numbers(s): If this document is being filed together with a new application, the execution date of the application is: 5/10/02, 5/10/02 A. Patent Application No.(s)

EXPRESS MAIL NO: \_\_ET926725925US B. Patent No.(s) 10, 145 2 30 THENE BY CERTIFY THAT THIS CORRESPONDENCE IS BEING DEPOSITED WITH THE U.S. POSTAL SERVICE AS EXPRESE MAIL IN AN ENVELOPE ADDRESSED TO: COMMISSIONER OF PATENTS AND THADEMARKS, WASHINGTON, D.C. 20231 APPLICANT AND/OFF ATTORNEY REQUESTS THE DATE OF DEPOSIT AS THE FILE DATE. DATE OF DEPOSITION S/13/02

Additional numbers attached? Yes No 5/13/02 5/13/02 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: Name: Steven Capella 7. Total fee (37 CFR 3.41):.....\$ 40.00 Internal Address: Zip 482 Enclosed - Any excess or insufficiency should be credited or debited to deposit account **International Business Machines Corporation** Authorized to be charged to deposit account 8. Deposit account number: Street Address: 2070 Route 52 10145230 05/21/2002 TDIAZ1 00000135 090458 **09-0458**, FI-152 40.00 CH 01 FC/581 (Attach duplicate copy of this page if paying by deposit account) ZIP: 12533 dity: Hopewell Junction State:/NY DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Steven Capella, Reg. No. 33,086 Signature Name of Person Signing Total number of pages including cover sheet, attachments, and document:

Docket No.: FIS920010215

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## **ASSIGNMENT**

For good and valuable consideration, we, Rajiv M. Ranada, Residing at 2 Noel Court, Brewster, NY 10509, a citizen of India; and G. S. Mathad, Residing at 5 Spurway, Poughkeepsie, NY 12603, a citizen of India; OSA

Hereby sell, assign and transfer to Infineon Technologies North America Corp., a corporation organized and existing under the laws of the state of Delaware, having its principal place of business at 1730 North First Street, San Jose, California, 95112, hereinafter "assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which had been executed by the undersigned concurrently herewith, and is entitled:

## METHOD TO INCREASE THE ETCH RATE AND DEPTH IN A HIGH ASPECT RATIO STRUCTURE

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been of shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do every thing possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

PATENT REEL: 012907 FRAME: 0928 Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Rajiv M. Ranade

May 10, 2002

G. S. Mathad

RECORDED: 05/13/2002

PATENT

**REEL: 012907 FRAME: 0929**